

FORM PTO-1449

INFORMATION DISCLOSURE CITATION

Atty Docket
END000008US1Serial No.
To be assignedApplicant
John U. Knickerbocker et al.Filing Date
HerewithGroup Art Unit
To be assigned

U.S. PATENT DOCUMENTS

Examiner Initial		Document Number	Date	Name	Class	Sub-Class	Filing Date
CA	AA	5,962,133	10/99	Yamaguchi et al.			
WA	AB	5,834,140	11/98	Wolski et al.			
WA	AC	5,551,627	9/96	Leicht et al.			
WA	AD	5,215,645	6/93	DiFranco et al.			
WA	AE	4,478,883	10/84	Bupp et al.			
	AF						
	AG						
	AH						
	AI						
	AJ						
	AK						

11046 U.S. PRO 09/817843

03/26/01

FOREIGN PATENT DOCUMENTS

		Document Number	Date	Country	Class	Sub-Class	Translation
	AL						Yes No
	AM						Yes No
	AN						Yes No
	AO						Yes No
	AP						Yes No

OTHER (Including Author, Title, Date, Pertinent Pages, etc.)

CA	AR	Manko, Howard H., "Designing the Solder Joint," <u>Solders and Soldering: Materials, Design, Production, and Analysis for Reliable Bonding</u> , McGraw-Hill Book Company, New York, New York, 1964, pp. 123-139
WA	AS	"Metfoils", Web page for EIS Circuit Supply, June 28, 2000
WA	AT	"Copper-Polymer Adhesion Process," <u>IBM Technical Disclosure Bulletin</u> , September 1987
WA	AU	"Plating Holes in Wired Circuit Boards," <u>IBM Technical Disclosure Bulletin</u> , May, 1980
	AV	"Rigid-Flexible Multilayer Boards," Dyconex Paper No. 3, 1997

Examiner

Date Considered

EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP § 600. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to Applicant(s).